Supporting information

A thermally responsive host–guest conductive hydrogel with self-healing properties

Yuting Zhu\textsuperscript{a,b}, Sidi Liu\textsuperscript{b}, Xiaoli Shi\textsuperscript{b,c,*}, Dong Han\textsuperscript{b,c} and Feng Liang\textsuperscript{a,b,*}

feng_liang@whu.edu.cn; shixl@nanoctr.cn

**Fig. S1** a) Tensile strain-stress behavior of PNIPAM, αCD-PNIPAM, PNIPAM/PANI, and αCD-PNIPAM/PANI hydrogels. b) Tensile stretching-releasing cycles of αCD-PNIPAM/PANI hydrogel (n=5).

**Fig. S2** a) Tensile strain-stress behavior of repaired αCD-PNIPAM/PANI hydrogel. b) Tensile stretching-releasing cycles of repaired αCD-PNIPAM/PANI hydrogel (n=5).
**Fig. S3** The thermal-responsive behavior of the repaired αCD-PNIPAM/PANI hydrogel under different temperatures.

**Fig. S4** a) The conductivities of ten PNIPAM/PANI hydrogel samples. b) The temperature-dependent conductivity of the PNIPAM/PANI hydrogel in the gel state. c) Cycling performance of the PNIPAM/PANI hydrogel. d) Resistance of PNIPAM/PANI cylinder-shaped hybrid hydrogels at different strains.